



MPC3150L Series

DIP8, DC Input, 0.8A, Gate Driver Photo Coupler

■ Features

- High isolation 5000 VRMS
- DC input with a high speed driver
- Operating temperature range - 40 °C to 100 °C
- Rail to rail output
- REACH & RoHS compliance
- Halogen free (Optional)
- MSL class 1
- Regulatory Approvals
 - UL - UL1577
 - VDE - EN60747-5-5
 - CQC – GB4943.1, GB8898

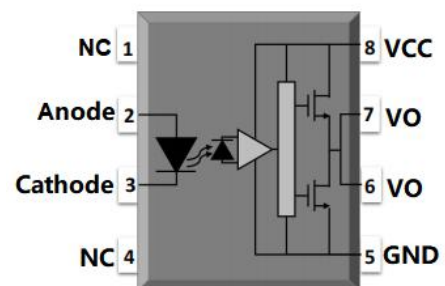
■ Applications

- IGBT/MOSFET gate drive
- Uninterruptible power supply
- Industrial Inverter
- AC/Brushless DC motor drives
- Switching power suppliers
- Induction Heating

■ Description

The MPC3150L series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to an integrated circuit with a power output stage in a plastic DIP8 package with different lead forming options.

■ Schematic





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ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT	Note
INPUT				
Forward Current	IF	25	mA	
Peak Forward Current	IFP	50	mA	1
Peak Transient Current	IF(trans)	1	A	2
Operating Frequency	f	50	kHz	
Reverse Voltage	VR	5	V	
Input Power Dissipation	PI	100	mW	
OUTPUT				
Supply Voltage	VCC	35	V	
Output Voltage	VO	35	V	
Peak Output Current	IO	0.8	A	
Output Power Dissipation	PO	250	mW	
COMMON				
Total Power Dissipation	Ptot	295	mW	
Isolation Voltage	Viso	5000	Vrms	3
Operating Temperature	Topr	-40~100	°C	
Storage Temperature	Tstg	-55~150	°C	
Soldering Temperature	Tsol	260	°C	4

Note 1. 50% duty, 1ms P.W

Note 2. $\leq 1\mu\text{s}$ P.W, 300pps

Note 3. AC For 1 Minute, R.H. = 40 ~ 60%

Note 4. For 10 seconds

TRUTH TABLE

LED	VDD-VSS "Positive Going" (Turn-on)	VDD-VSS "Negative Going" (Turn-off)	VO
Off	0V to 30V	0V to 30V	Low
On	0V to 11.5V	0V to 10V	Low
On	11.5V to 13.5V	10V to 12V	Transition
On	13.5V to 30V	12V to 30V	High



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RECOMMENDED OPERATION CONDITIONS

PARAMETER	SYMBOL	MIN.	MA.	UNIT
Operating Temperature	TA	-40	100	°C
Supply Voltage	VCC	10	30	V
Input Current (ON)	IF(ON)	7	16	mA
Input Voltage (OFF)	VF(OFF)	0	0.8	V

ELECTRICAL OPTICAL CHARACTERISTICS (VCC=30V, VEE=GND, TA=25°C unless specified otherwise)

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
INPUT CHARACTERISTICS							
Forward Voltage	VF	-	1.38	1.8	V	IF=10mA	
Reverse Current	IR	-	-	10	μA	VR=5V	
Input Capacitance	Cin	-	13	-	pF	V=0, f=1MHz	
OUTPUT CHARACTERISTICS							
High Level Supply Current	ICCH	-	1.9	3	mA	IF= 7mA to 10mA, VO= Open	
Low Level Supply Current	ICCL	-	2.1	3	mA	VF = 0 to 0.8V, VO= Open	
TRANSFER CHARACTERISTICS							
High Level Output Voltage	VOH	VCC-2.5	VCC-1.5	-	V	IF= 10mA, IO= -100mA	
Low Level Output Voltage	VOL	-	VEE+0.25	VEE+0.4	V	IF= 0mA, IO= 100mA	
High Level Output Current	IOPH	-0.3	-	-	A	VO= VCC-3.0V	
		-0.8	-	-	A	VO= VCC-6.0V	
Low Level Output Current	IOPL	0.3	-	-	A	VO= VEE+1.5V	
		0.8	-	-	A	VO= VEE+2.5V	
Input Threshold Current	IFLH	-	2	5	mA	IO= 0mA, VO> 5V	
Input Threshold Voltage	VFHL	0.8	-	-	V	IO= 0mA, VO< 5V	
Under Voltage Lockout Threshold	VUVLO+	6.9	7.8	8.7	V	IO= 10mA, VO> 5V	
	VUVLO-	5.9	6.7	7.5	V	IO= 10mA, VO< 5V	
Isolation Resistance	Riso	10 ¹²	10 ¹⁴	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance	CIO	-	1.0	-	pF	V=0, f=1MHz	



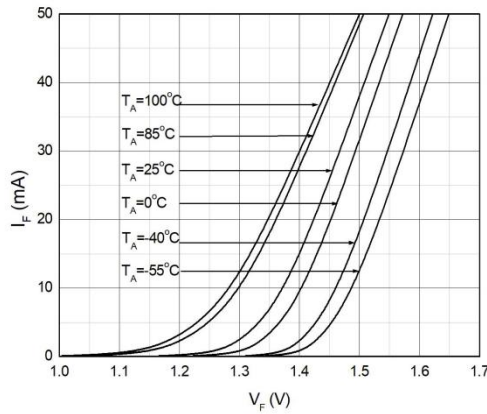
MPC3150L Series

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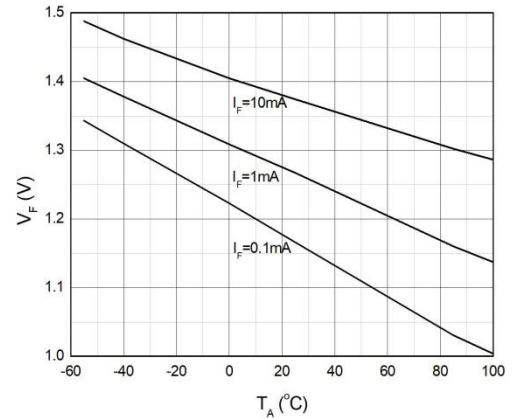
ELECTRICAL OPTICAL CHARACTERISTICS (VCC=30V, VEE=GND, TA=25°C unless specified otherwise)

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
SWITCHING CHARACTERISTICS							
Propagation Delay Time to Output Low Level	TPHL	50	250	500	ns	IF= 7 to 16mA, CL= 1nF, RL= 30Ω, f= 10kHz, Duty = 50%, TA= 25 °C	
Propagation Delay Time to Output High Level	TPLH	50	220	500	ns		
Pulse Width Distortion	TPHL-TPLH	-	30	200	ns		
Propagation Delay Skew	tPSK	-200	-	200	ns		
Rise Time	tr	-	30	-	ns		
Fall Time	tf	-	30	-	ns		
UVLO Turn On Delay	tUVLO(ON)	-	1.6	-	μs	IF= 10mA, VO> 5V	
UVLO Turn Off Delay	tUVLO(OFF)	-	0.4	-	μs	IF= 10mA, VO< 5V	
Common Mode Transient Immunity at Logic High	CMH	-20	-	-	kV/μs	IF=7 to 16mA VCC= 30V, TA= 25 °C, VCM= 2kV	
Common Mode Transient Immunity at Logic Low	CML	20	-	-	kV/μs	IF=0mA VCC= 30V, RL, TA= 25 °C, VCM= 2kV	

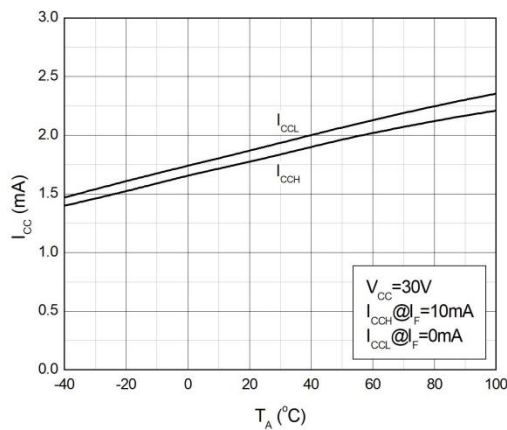
CHARACTERISTIC CURVES



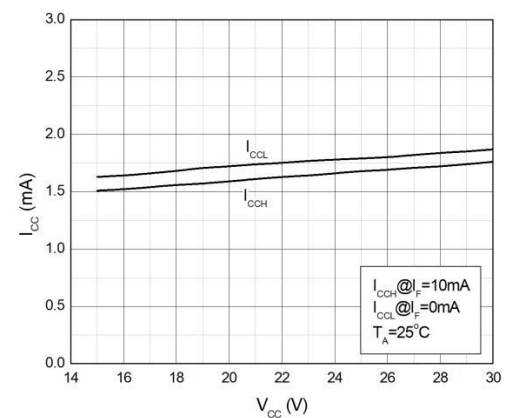
**Fig.1 Forward Current
vs. Forward Voltage**



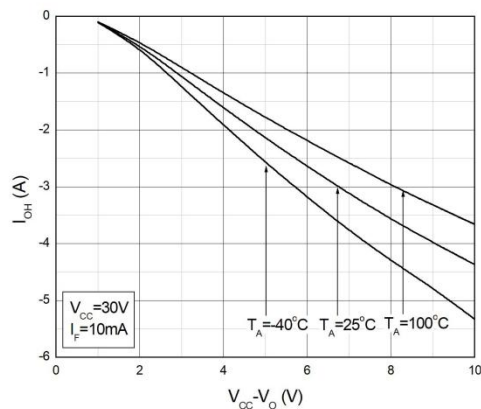
**Fig.2 Forward Voltage
vs. Ambient Temperature**



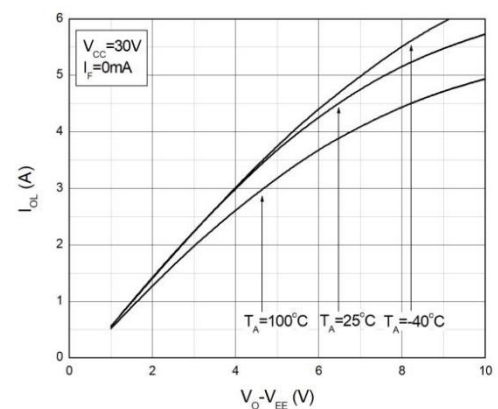
**Fig.3 Supply Current
vs. Ambient Temperature**



**Fig.4 Supply Current
vs. Supply Voltage**



**Fig.5 High Level Output Voltage
vs. High Level Output Current**



**Fig.6 Low Level Output Voltage
vs. Low Level Output Current**

CHARACTERISTIC CURVES

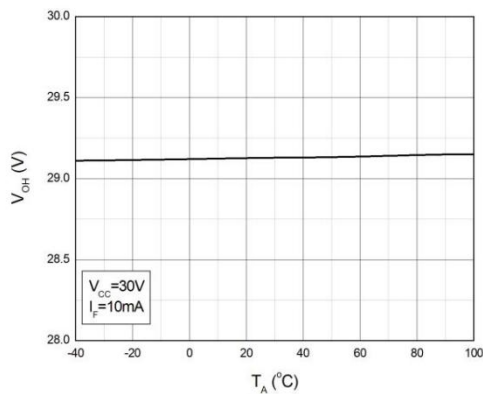


Fig.7 High Level Output Voltage vs. Ambient Temperature

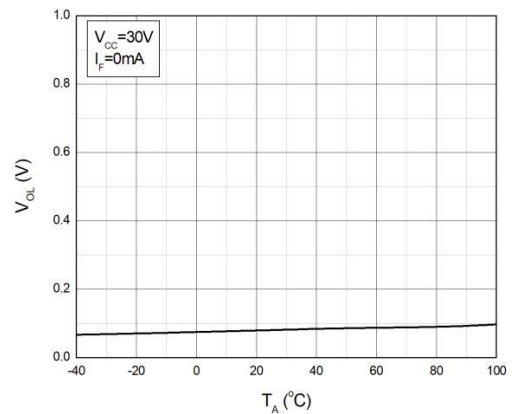


Fig.8 Low Level Output Voltage vs. Ambient Temperature

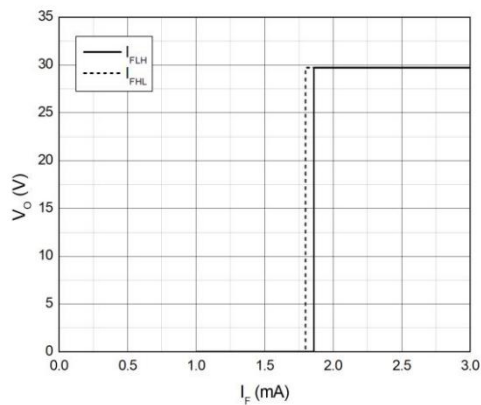


Fig.9 Output Voltage vs. Forward Current

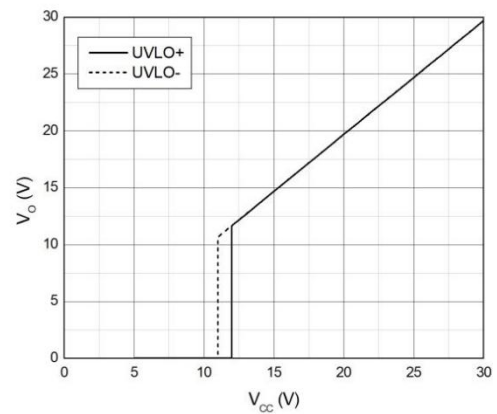


Fig.10 Output Voltage vs. Supply Voltage

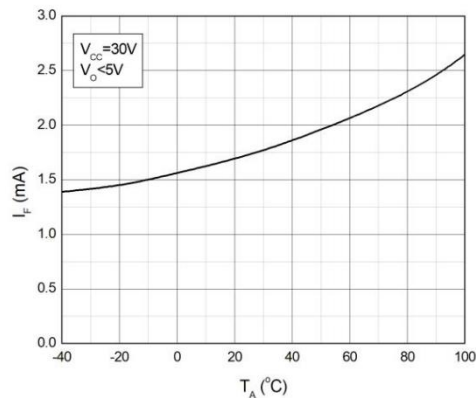


Fig.11 Forward Current vs. Ambient Temperature

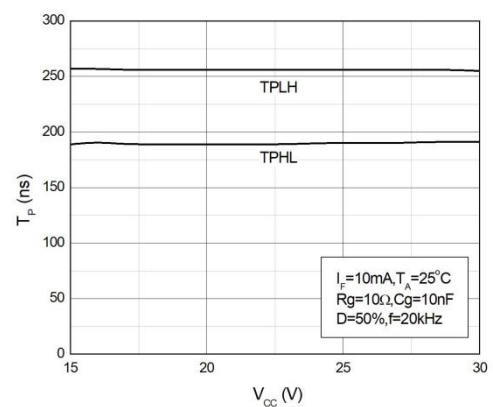
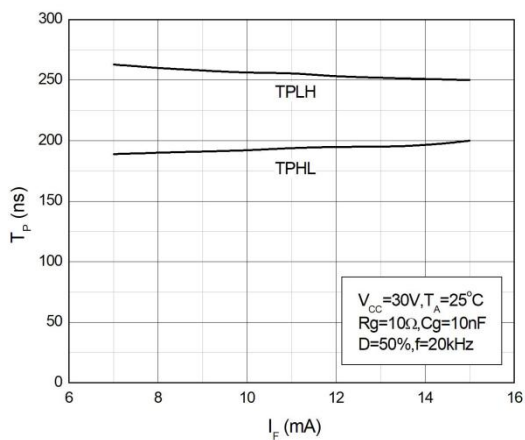
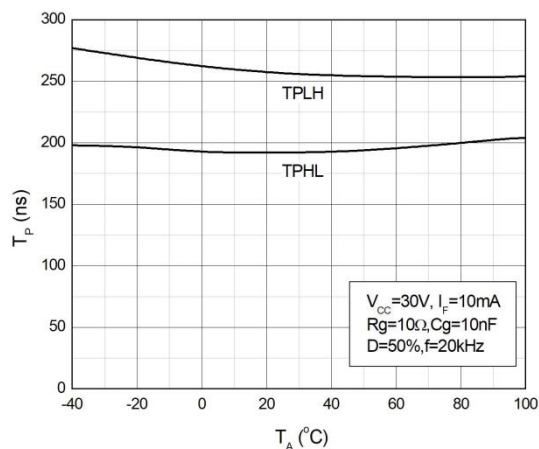


Fig.12 Propagation Delay vs. Supply Voltage

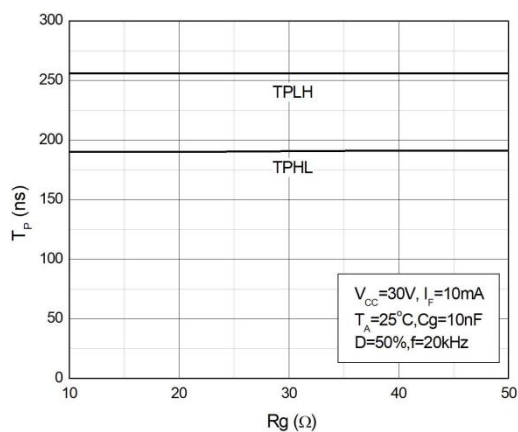
CHARACTERISTIC CURVES



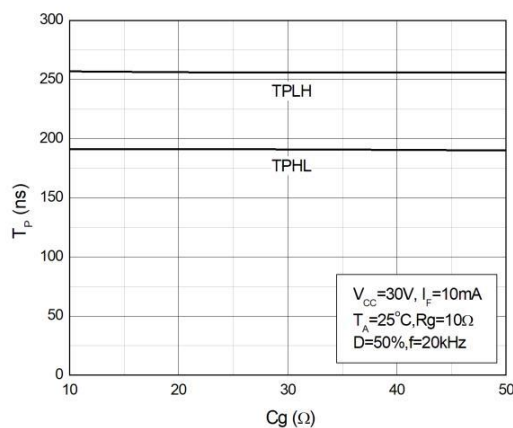
**Fig.13 Propagation Delay
vs. Forward Current**



**Fig.14 Propagation Delay
vs. Ambient Temperature**



**Fig.15 Propagation Delay
vs. Load Resistance**



**Fig.16 Propagation Delay
vs. Load Capacitance**

TEST CIRCUITS

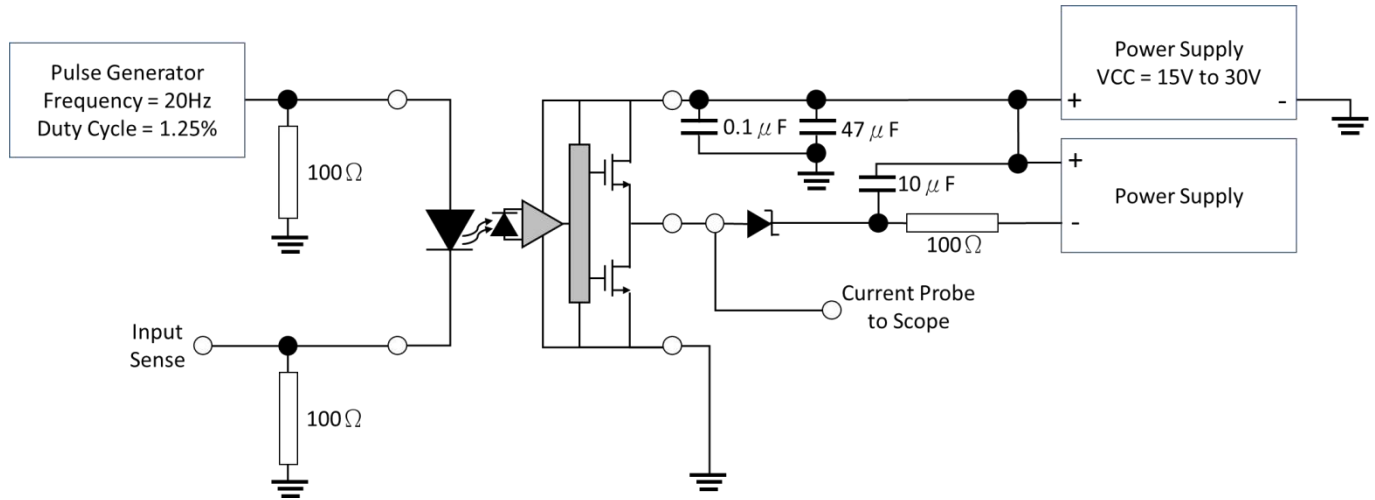


Fig.17 Test Circuits for IOH

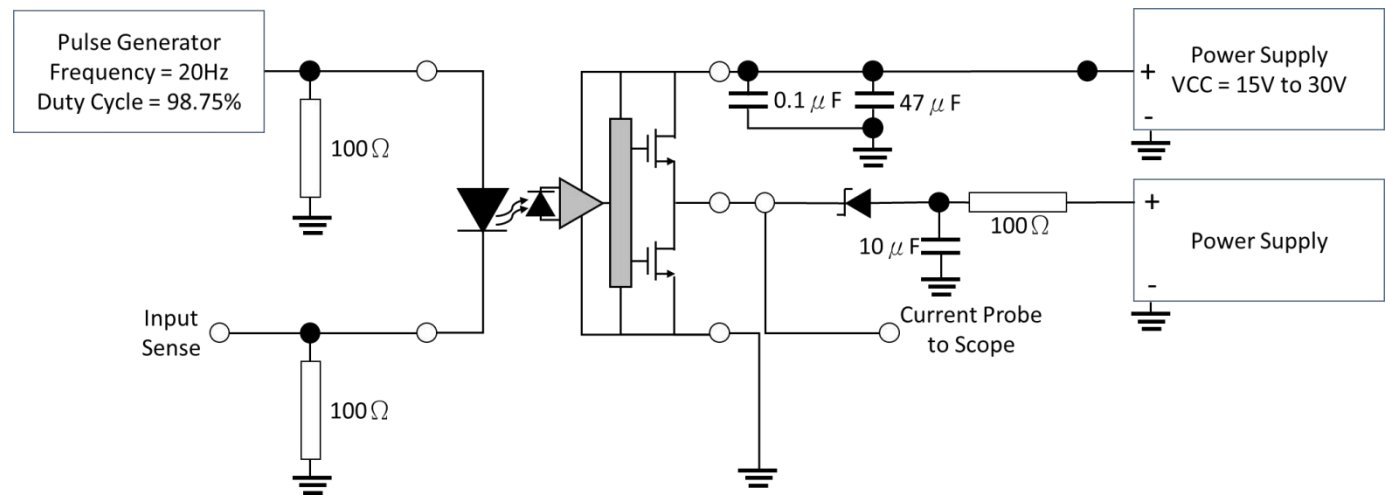


Fig.18 Test Circuits for IOL

TEST CIRCUITS

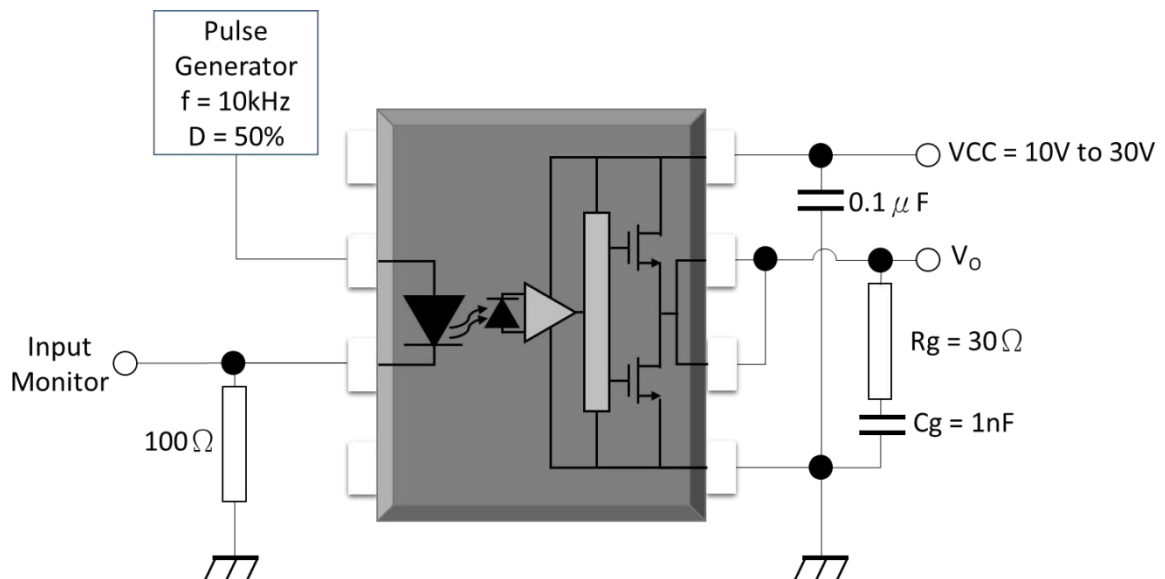


Fig.19 Test Circuits for TPHL, TPLH, tr, tf

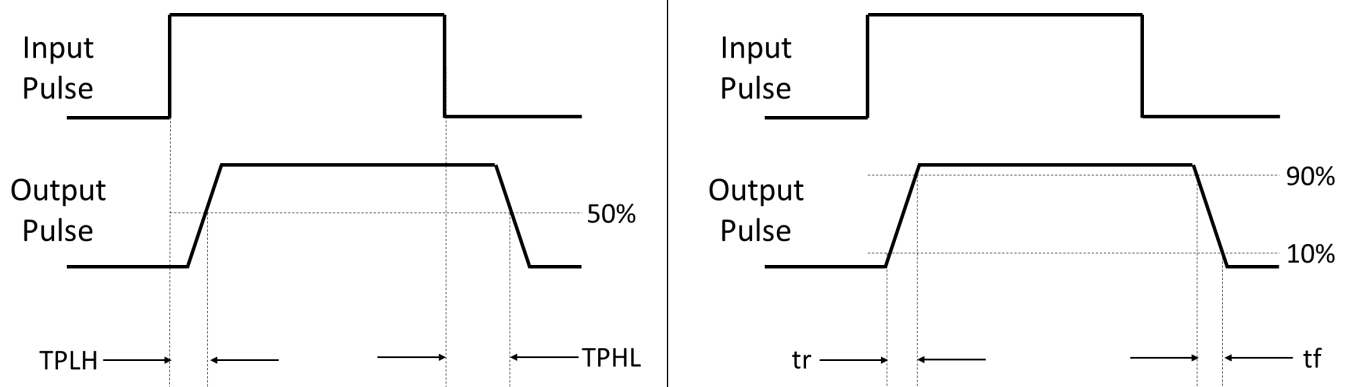


Fig.20 Waveforms of TPHL, TPLH, tr, tf

TEST CIRCUITS

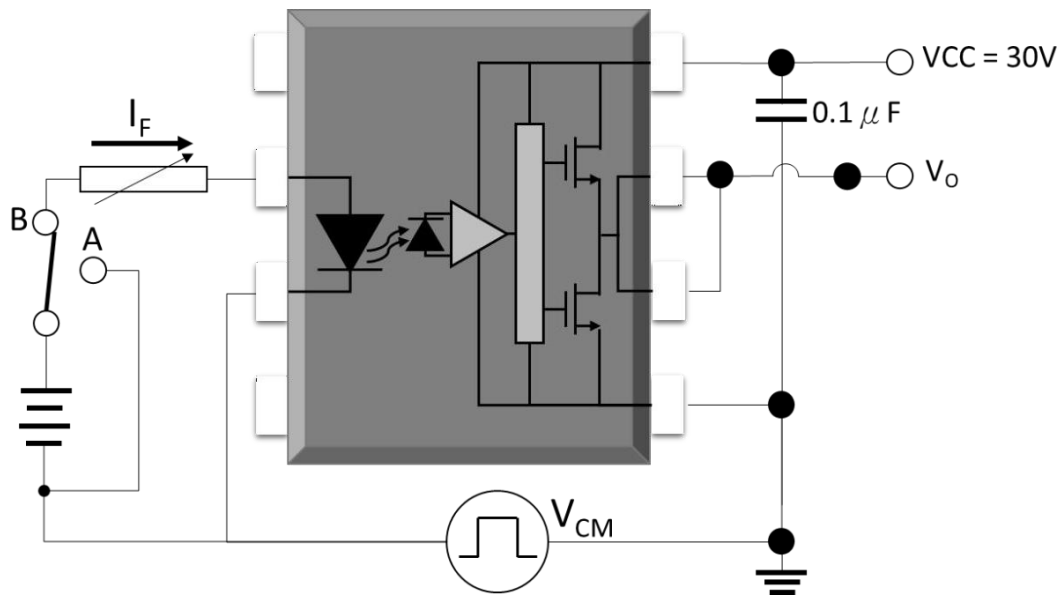


Fig.21 Test Circuits for Common Mode Transient Immunity

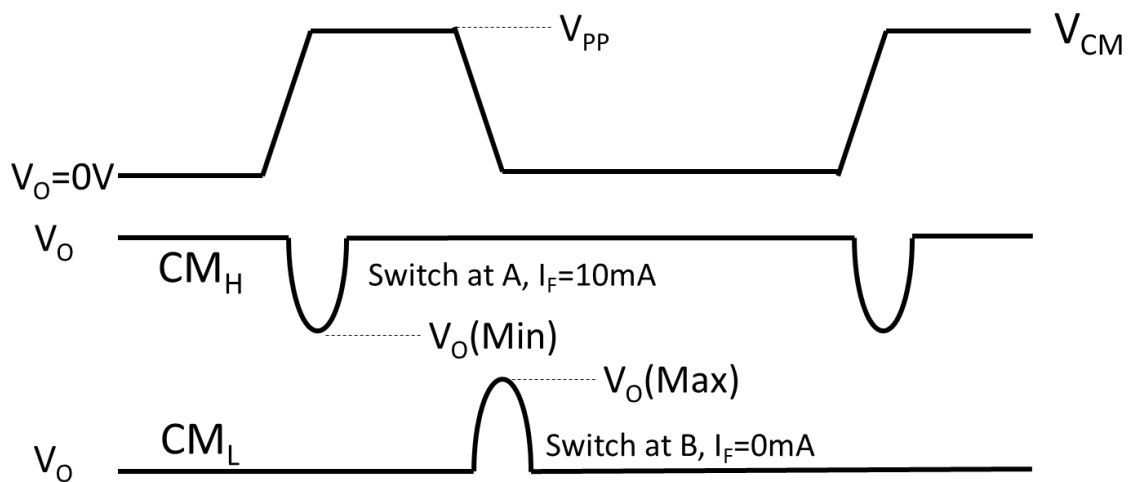
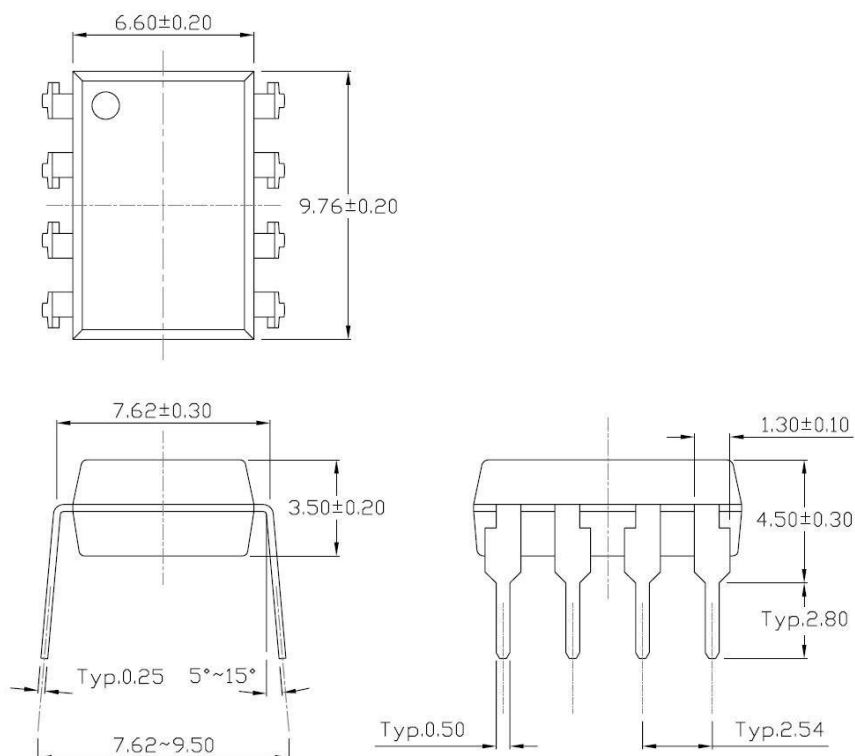


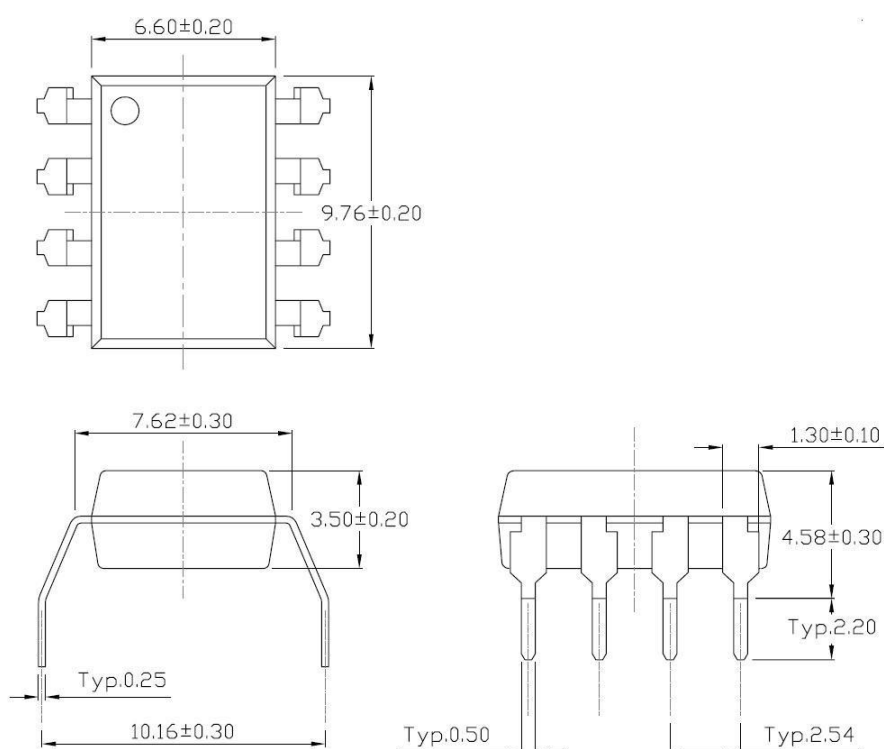
Fig.22 Waveforms of Common Mode Transient Immunity

PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

Standard DIP – Through Hole (DIP Type)

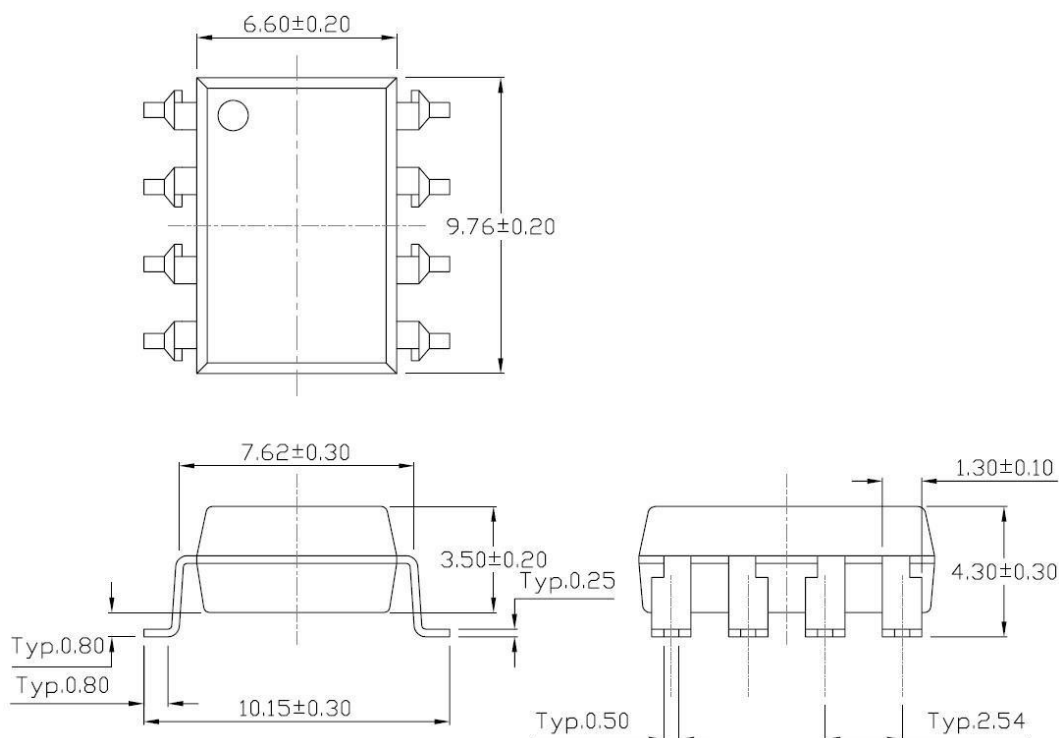


Gullwing (400mil) Lead Forming – Through Hole (M Type)

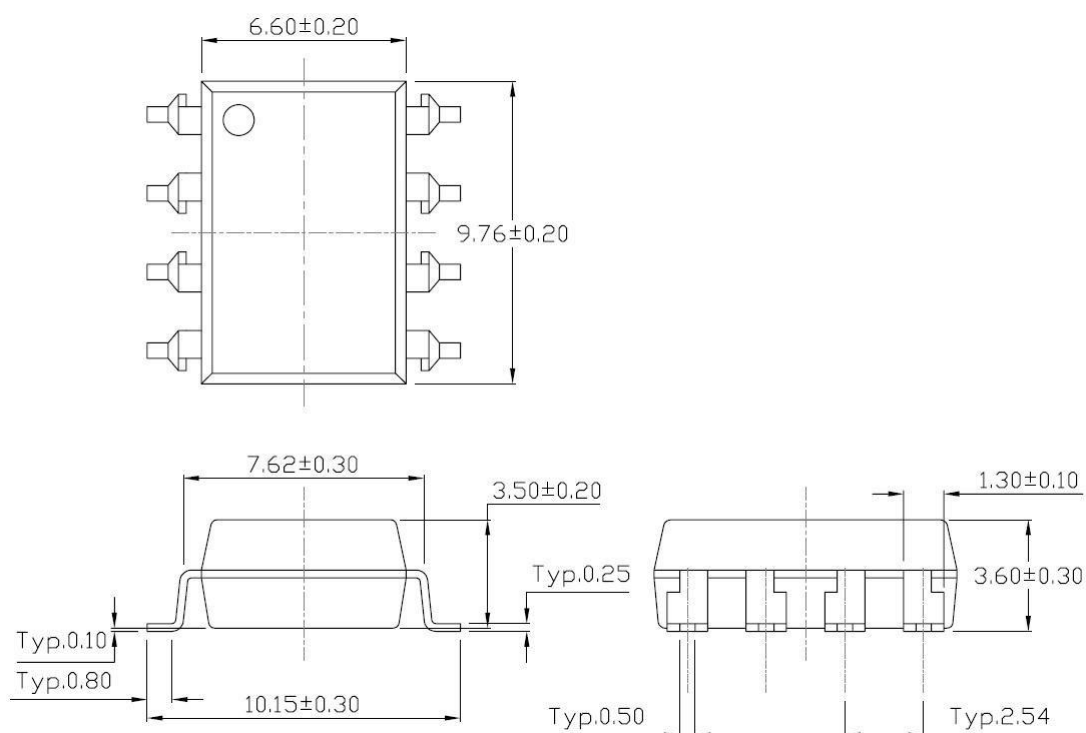


PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

Surface Mount Lead Forming (S Type)

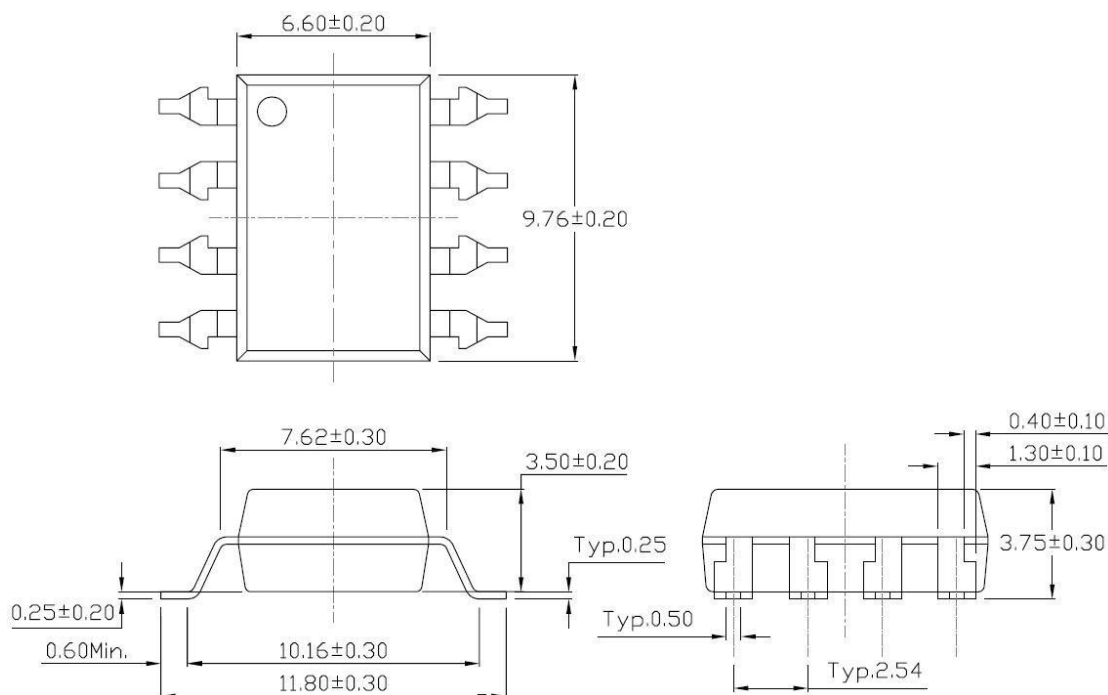


Surface Mount (Low Profile) Lead Forming (SL Type)



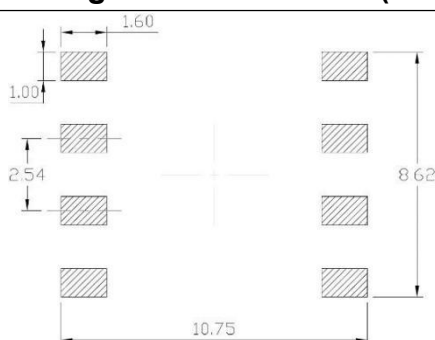
PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

Surface Mount (Gullwing) Lead Forming (SLM Type)

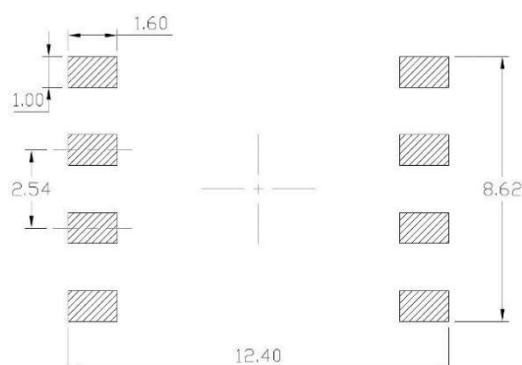


Recommended Solder Mask (Dimensions in mm unless otherwise stated)

Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming

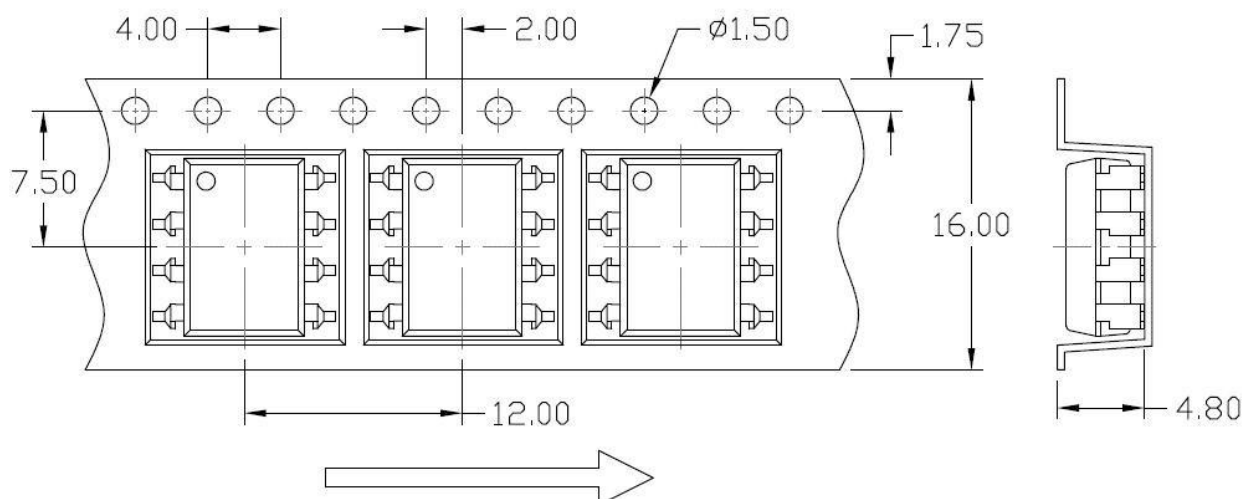


Surface Mount (Gullwing) Lead Forming

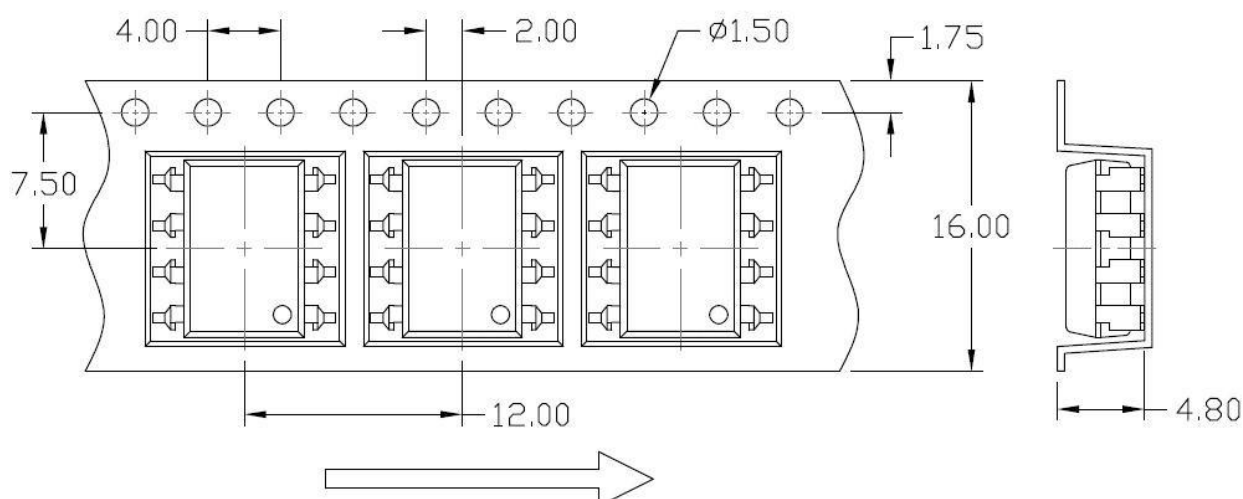


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option S(T1) & SL(T1)

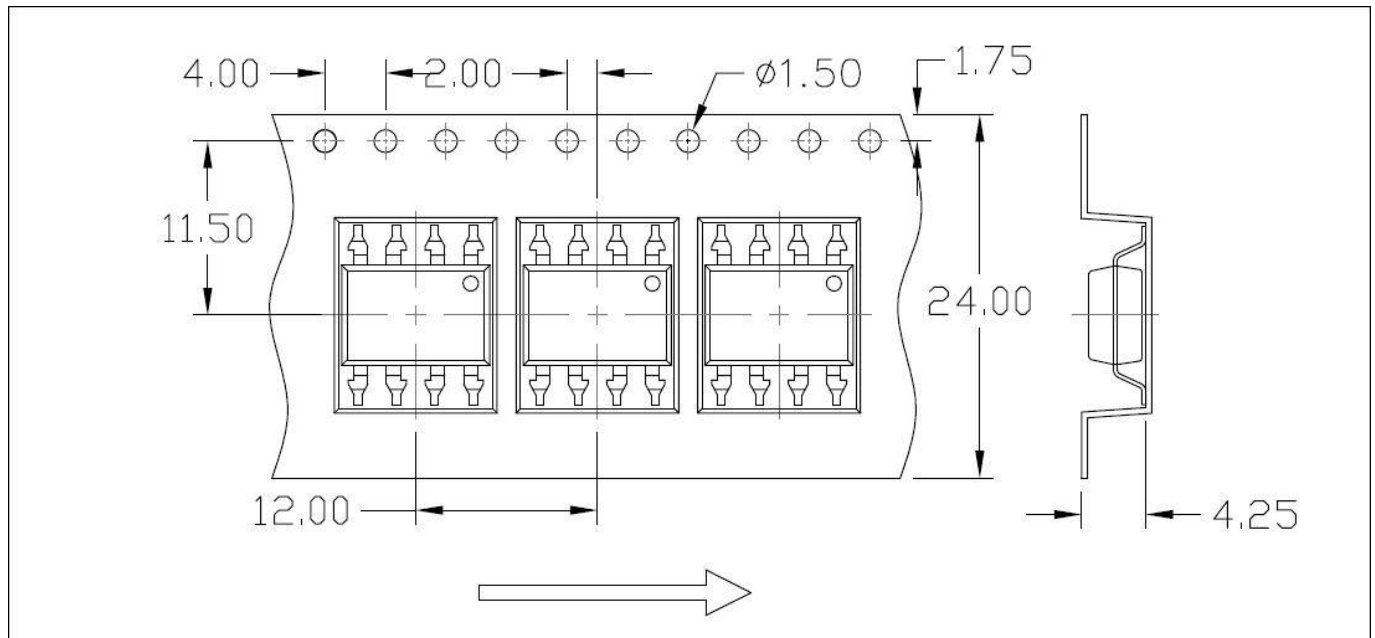


Option S(T2) & SL(T2)

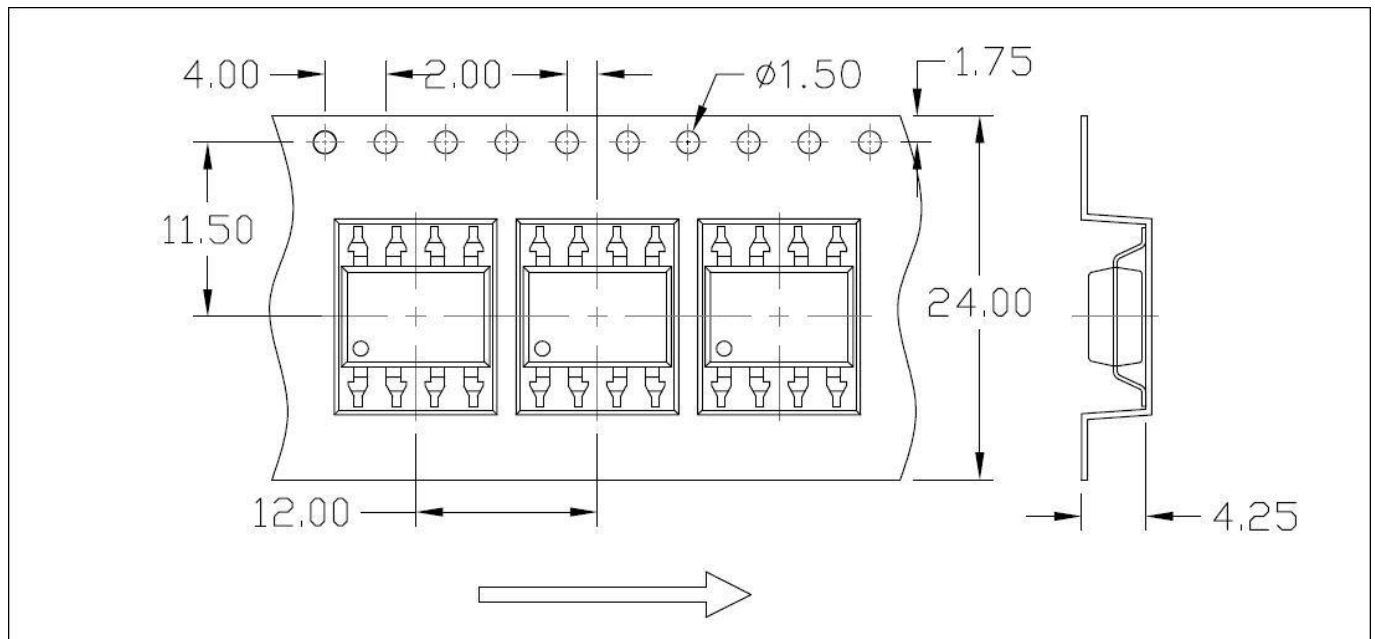


Carrier Tape Specifications (Dimensions in mm unless otherwise stated)

Option SLM(T1)

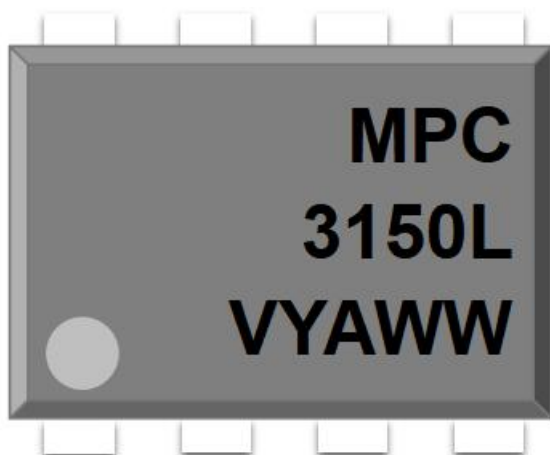


Option SLM(T2)



ORDERING AND MARKING INFORMATION

MARKING INFORMATION



MPC : Company Abbr.
3150L : Part Number
V : VDE Option
Y : Fiscal Year
A : Manufacturing Code
WW : Work Week

ORDERING INFORMATION

MPC3150L(Y)(Z)-GV

MPC – Company Abbr.

3150L– Part Number

Y – Lead Form Option (M/S/SL/None)

Z – Tape and Reel Option (T1/T2)

G – Material Option (G: Green, None: Non-Green)

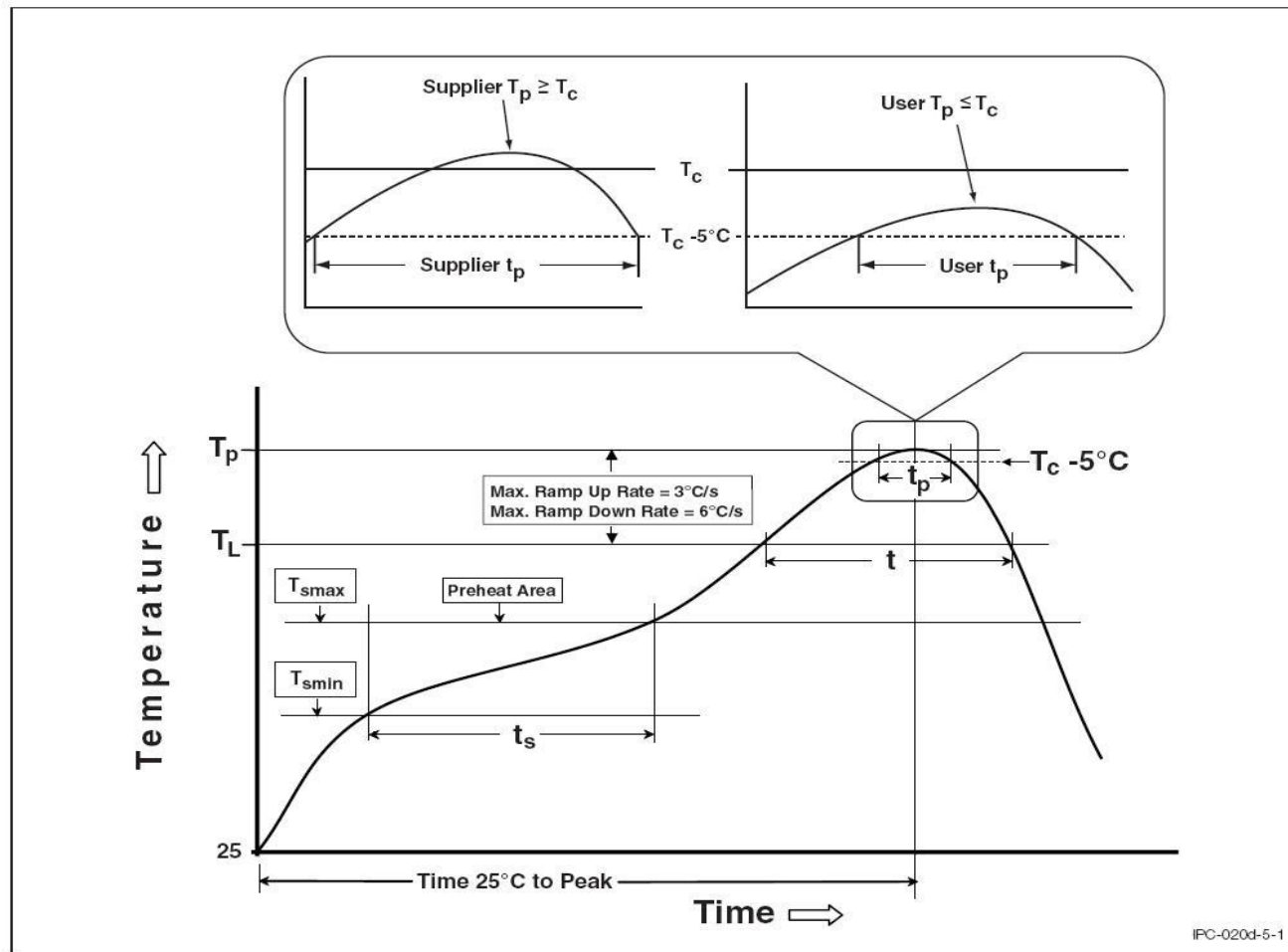
V – VDE Option (V or None)

PACKING QUANTITY

Option	Quantity	Quantity – Inner box	Quantity – Outer box
None	50 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 16k Units
M	50 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 16k Units
S(T1)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units
S(T2)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units
SL(T1)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units
SL(T2)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units

REFLOW INFORMATION

REFLOW PROFILE



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (T _{smin})	100	150°C
Temperature Max. (T _{smax})	150	200°C
Time (t _s) from (T _{smin} to T _{smax})	60-120 seconds	60-120 seconds
Ramp-up Rate (t _L to t _P)	3°C/second max.	3°C/second max.
Liquidous Temperature (T _L)	183°C	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.



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DISCLAIMER

- Our company is continually improving the quality, reliability, function and design. Our company reserves the right to make changes without further notices.
- The characteristic curves shown in this datasheet are representing typical performance which are not guaranteed.
- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Immerge unit's body in solder paste is not recommended.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.

■ Revision History

Version	Date	Subjects (major changes since last revision)
1.0	2022-07-21	Datasheet Complete